molex	PRODUCT SPECIFICATION
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### [1. SCOPE]

This specification covers the 0.8 mm PITCH BOARD TO BOARD CONNECTOR series.

### [2. PRODUCT NAME AND PART NUMBER]

Product Name	Part Number
Receptacle Housing Assembly	104249-0891
Embossed Tape Package for 104249-0891	104249-0810
Plug Housing Assembly	104250-0800
Embossed Tape Package for 104250-0800	104250-0820

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#### [3. RATINGS]

Item	Standard				
Rated Voltage (MAX.)	50	V			
	For 4 PINS	0.3A / 1PIN	[ AC (rms) / DC ]		
Rated Current (MAX.)	For 4 PINS	4.5A / 1PIN <sup>*3</sup>			
Ambient Temperature Range <sup>1</sup>		-40°C ~ + 85°C <sup>*2</sup>			
	Temperature		-10°C∼+50°C		
Storage condition after opening the Humidity prevention package	Humidity		85%R.H. MAX. (No condensation)		
prevention package	Term		Term		For 6 months after shipping (unopened package)

\*1. Non-operating connectors after reflow must follow the operating temperature range condition.
\*2. Including the terminal temperature rise generated by conducting electricity.
\*3. When 2 circuits are constructed via PWB/FPC circuit, 9A of current per 2-circuit is applicable. But the circuit via fitting nail shall not be acceptable for excessive temperature increase.

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#### [4. PERFORMANCE]

#### 4-1. Electrical Performance

	ltem	Test Condition	Requirement
4-1-1	Contact Resistance Mate connectors and measured by dry circuit, 20mV MAX., 10mA. MAX. (JIS C5402 5.4)		10 milliohm MAX. /PIN
4-1-2	Insulation Resistance	Mate connectors and apply 250V DC between adjacent terminal and ground. (JIS C5402 5.2/MIL-STD-202 Method 302)	100 Mega ohm MIN.
4-1-3	Dielectric Strength	Mate connectors and apply 250V AC (rms) for 1 minute between adjacent terminal and ground. (JIS C5402 5.1/MIL-STD-202 Method 301)	No Breakdown on function
4-1-4 Temperature Rise		Mate connectors and conduct the maximum rated current. (UL 498)	30 °C MAX.

#### 4-2. Mechanical Performance

	Item	Test Condition	Requirement	
4.0.1	Insertion and Withdrawal	Insert and withdraw connectors at the	Insertion	46.5 N MAX. {4.74 kgf}
4-2-1	Force	speed rate of 5cycle per minute.	Withdrawal	10.0 N MIN. {1.02 kgf}
4-2-2	Terminal / Housing Retention Force	Apply axial pull out force at the speed rate of 25±3 mm/minute on the terminal assembled in the housing.	0.15N {0.015 kgf} MIN.	

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#### 4-3. Environmental Performance and Others

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	Item		Tes	st Condition		Requirement	
4-;	3-1	Repeated Insertion / Withdrawal	When mated up to the rate of 5 cycle	o 10 cycles repeatedly by es per minute.	Contact Resistance	20milliohm	MAX.
					Appearance	No Damage on function	
4-:	3-2	Vibration		5~10 Hz in 1 minute. s in each X.Y.Z.axes.	Contact Resistance	20milliohm	MAX.
						1.0 microseco	nd MAX.
					Appearance	No Damage on	function
4-3-3	3-3	3 Mechanical Shock	490m/s <sup>2</sup> { 50G } , 3 strokes in each X.Y.Z.axes. (JIS C60068-2-27/MIL-STD-202 Method 213)		Contact Resistance	20milliohm MAX.	
					Discontinuity	1.0 microsecond MAX.	
4-:			85±2°C, 96 hours (JIS C60068-2-2/MIL-STD-202		Appearance	No Damage on	function
4-1	5-4	Resistance	Method 108)	MIL-31D-202	Contact Resistance	20milliohm	MAX.
	0.5	Cold	–40±3°C, 96 hour	s	Appearance	No Damage on	function
4-,	3-5	Resistance	(JIS C60068-2-1)		Contact Resistance	20milliohm MAX.	
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		ltem	Too	st Condition		Requirement	
Item							
					Appearance	No Damage on	function
1-3	3-6	Humidity	Temperature : 60 Relative Humidity Duration : 96 hou	: 90~95%	Contact Resistance	20milliohm I	MAX.
4-0	5-0	Thurmonty	(JIS C60068-2-3/ Method 103)		Dielectric Strength	Must meet 4	4-1-3
				Insulation Resistance	50 Mega ohn	n MIN.	
4-3	3-7	Temperature	5 cycles of : a) – 55°C, 30 m		Appearance	No Damage on	function
-T (		Cycling	b) + 85°C, 30 m (JIS C0025)	ninutes	Contact Resistance	20milliohm I	MAX.
1-9	3-8	Salt Spray	from the 5±1% so		Appearance	No Damage on	function
4-0	0-0	Gan Opray	(JIS C60068-2-11 Method 101)	/MIL-STD-202	Contact Resistance	20milliohm MAX.	
4.5	3-9	$SO_2$ Gas		Density of SO₂ gas : 50±5ppm		No Damage on	function
4-0	5-5	30 <sub>2</sub> Gas	Temperature Duration	: 40±2°C : 24 hours	Contact Resistance	20milliohm l	MAX.
4-3	8-10	Solderability	Soldering Time Solder Temperatu	: 3±0.5 sec. ure : 245±5 °C	Solder Wetting	95% of immers must show no pin holes	voids,
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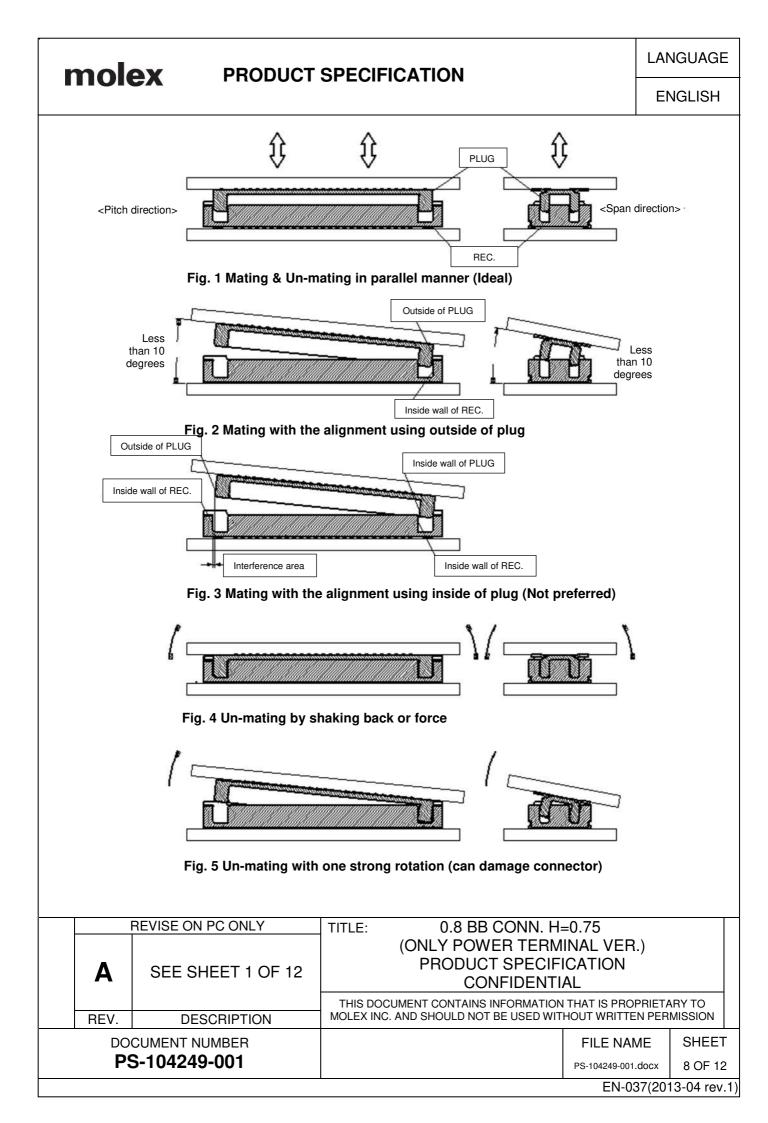
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Item		Tes	t Condition	Requirement			
4	4-3-11 Resistance to Soldering Heat (Soldering iron method) 0.2mm from termin Soldering time : 5 Solder temperatur			Appearance	No Damage o	n function	
L		/			( ): { }:		Standard Unit
[5	. PRC	DUCT SHAPE, D	IMENSIONS AND	MATERIALS			
		er to the drawing. AND RoHS COM	IPLIANT.				
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[6. INFRAREI	REFLOW CONDITION								
	250℃ +5℃/-10℃ MAX (Peak Temperature.)								
		30~60 Secon (230°C MIN.)							
	90~120 Seconds (Pre-heat 150~200°C)								
		ERATURE CONDITION GRAPH TURE ON BOARD PATTERN SIDE)							
	NOTE; Please check the reflow soldering condition by your own devices beforehand. Because the condition changes by the soldering devices, PWB, and so on. Also please check mount condition in case of Nitrogen atmosphere.								
[7. INSTRUC	TION UPON USAGE								
Please lo In the cas	se of skew mating, please de	llel manner. (Fig. 1) ec. housing and the plug after mating. o not mate the connector at more than 10° lea at an angle as this way, because the housing							
Please d Please b This mar	o not mate connector at an a								
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### **PRODUCT SPECIFICATION**

#### [11. OTHERS]

- 1. Prohibit from applying an excessive load to the housing around terminals before mounting the connector onto PWB.
- 2. Please do not touch the terminals and fitting nails before or after mounting the connector onto PWB.
- 3. There may be slight differences in the housing coloring, but there will be no influence on the product's performance.
- Specification is met although black spots, scratch on the housing, or a minim air bubble and so on may exist on mold resin.
   As LCP is used as the mold material, the weld lines may be visible in some cases. However, they do not affect product performance.
- 5. Please ensure that the connector is fully mated. After setting the connector and cable assembly in the device, please ensure that the connector does not become unengaged due to vibration and shock conditions. There may be case of coming off if mating is insufficient and connectors get an inclines of 5 degrees.
- There is instruction of design the following. Please prepared without pattern area. When an excessive mounting gap occurs, there may be contact area solder wicking.
- The mounting specification for coplanarity does not include the influence of warpage of PWB. The warpage of PWB should be a maximum of 0.02mm if measuring from one connector edge to the other.
- 8. This connector performance was tested based on using rigid epoxy-glass PWB. If you need to mount the connector on FPC, please make sure to conduct the reflow test in advance.
- Recommend to place any stiffener board or film on the backside of FFC/FPC when you mount the connector to prevent deformation.
   Due to the low profile design, please be cautious to set the reflow condition to prevent solder wicking.
- 10. Fillet condition might be different depending on the mounting condition, please care of fillet condition of connectors.
- 11. There may be a case which changes housing color by depending on reflow conditions. However, it does not effect on connector performance.
- 12. There may be a case that the plated surface looks wavy by depending on reflow conditions. However, it does not effect on connector performance.
- 13. There is no influence in the product performance though discoloration might be seen in the soldering tail after the reflow. There is no solder on the top surface of tail in spec, and there is no influence in performance.

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- 14. Because this product has a cut off area on the tip of the terminal, the solderability performance in this area is not as good as compared to the side/back of the terminal. However, by building a good soldering fillet at the side/back of the terminal, there will be no issue on either the product function or the retention force of PWB.
- 15. If you leave any soldering area on this product open, there may be the possibility of a missing terminal short circuiting between pins, terminal buckling or the potential for the connector to come off of PWB. Therefore, please solder all of the terminals and fitting nails on PWB.
- 16. If there is accidental contact with the connector while it is going through the reflow machine, there may be deformation or damage caused to the connector. Please check to prevent this.
- 17. When conducting manual repairs using a soldering iron, please follow the soldering conditions shown in the product specification. If the conditions in the product spec are not followed, it may cause the terminals to fall off, a change in the contact gap, a deformation of the housing, melting of the housing, and damage the connector.
- 18. When conducting manual repairs with a soldering iron, please do not use excessive solder or flux than needed. This may cause solder wicking or flux wicking issues, also it may eventually cause a contact defect and functional issues.
- 19. Please do not stack up PWB directly after mounted the connector on it.
- 20. If an alternative solder past is used (other than Sn-Ag-Cu 96.5%-3%-0.5%), please ensure in advance that the solder ability and PWB peeling force will not have any issues.
- 21. Please do not use the connector in a condition where the wire, PWB, or the contact area is experiencing a sympathetic vibration of wires and PWB, and constant movement of devices. This may cause a defect in the contact due to the contact area being worn down. Therefore, please fix wires and PWB on the chassis, and reduces sympathetic vibration.
- 22. Please do not conduct any "washing process" on the connector because it may damage the product's function.
- 23. Please investigate the mounting condition (reflow soldering condition) on your own devices beforehand. The mounting conditions may change due to the soldering temperature, soldering paste, air reflow machine, Nitrogen reflow machine, and the type of PWB. The different mounting conditions may have an influence on the product's performance.
- 24. Please do not use the connector alone to provide mechanical support for PWB. Please ensure that there is a fixed structure on the phone chassis or other component support for PWB.
- 25. There should not be more than one board to board connection between two separate PWB. When mounting several board to board connectors between parallel PWB, please ensure to separate each mated board to board connectors by using separate PWB.
- 26. Please keep enough clearance between connector and chassis of your application in order not to apply any pressure on the connector.

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27.	This product is not designed for the mating and un-mating of the connectors to be performed condition of an active electrical circuit. It may cause a spark and product defect if the connect mated and un-mated in this way.	
28.	After mated the connector, please do not allow PWB to apply pressure on the connector in eit direction or the span direction. It may cause damage to the connector and may crack the sole	
29.	Due to the low profile design, there might be the flux going up to receptacle terminal beam pa	art, anchor

30. To prevent excessive temperature increase, please make appropriate circuit design for PWB/FPC on which the connectors mount.

part and the other side of plug contacting part. However, it does not effect on connector performance.

31. Notes of caution about wiring of power circuit

- To prevent excessive temperature increase, please make appropriate circuit design for PWB/FPC on which the connectors mount.

- The heat capacity of micro connector is very lower than PWB, so the temperature rise by power distribution depends on the wiring condition of PWB mainly. Also the reasonable dimension of wiring section on PWB is 1.0mm width x 35µm thickness in case of applying 1A.

- It is possible to apply Max. 9A on this connector by shunting current to 2 power pins on PWB wiring. But the circuit via fitting nail shall not be acceptable for excessive temperature increase. In addition, the fitting nail in this product can't be acceptable for the electrical circuit.

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